

Re-Configurable 6 Output CMOS Oscillator Applications

- Fixed & Re-Configurable Multi-Frequency Oscillator
- Intuitive software and PC interface
- Easily update system
- Software flexible, quick upgrades and changes
- Industry-standard packaging saves on board space
- Mult. outputs 1 pkg vs. mult. osc & assoc. comp.
- Increased integration

- High-end multimedia
- Communications
- Industrial
- A/D converters
- Consumer Applications

Series CCE6RC



Part Numbering Example: CCE6RC 1A 200.0 / 150.0 / 125.0 / 100.0 / 75.0 / 12.0

| | | | | | | | |
|---------------|---------------------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| CCE6RC | 1A | 200 | 150 | 125 | 100 | 75 | 12 |
| SERIES | PACKAGE STYLE | FREQUENCY A | FREQUENCY B | FREQUENCY C | FREQUENCY D | FREQUENCY E | FREQUENCY R |
| | 1A=14 pin dip 9=9.6x11.4 SMD | 0.2 - 200 MHz | 0.2 - 200 MHz | 0.2 - 200 MHz | 0.2 - 200 MHz | 25 - 200 MHz | |

| Specifications: | Min | Typ | Max | Unit |
|-------------------------------------------------------------|--------------------------|-----|---------------|----------|
| Frequency Range: | | | | |
| Output A CMOS | 0.2 | | 200 | MHz |
| Output B CMOS | 0.2 | | 200 | MHz |
| Output C CMOS | 0.2 | | 200 | MHz |
| Output D CMOS | 0.2 | | 200 | MHz |
| Output E CMOS | 25 | | 200 | MHz |
| Output R Fixed | | 12 | | MHz |
| Available Stability Options: | -50 | | 50 | ppm |
| Supply Voltage: | 3.135 | 3.3 | 3.465 | V |
| Operating Temperature Range Options: | -40 | | 85 | °C |
| Storage Temperature: | -55 | | 125 | °C |
| Duty Cycle: | 40 45 | | 60 55 | % % |
| Start-Up Time: | | 3 | 10 | mS |
| Aging (PPM/1st Year): Ta=25C, Vdd=3.3V | | | ±5 | |
| Static Discharge Voltage Mil-Std 883, method 3015 | 2000 | | | V |
| Output Load: CMOS, < 40 MHz CMOS, ≥ 40 MHz | | | 30 15 | pF pF |
| Output Level: | CMOS | | | |
| Packaging: | 25 / Tube Tape & Reel | | 14 pin SMD | |

Notes: Recommended .01 μF bypass capacitor from Vcc to GND. Capacitor should be as close to oscillator as possible.

Cardinal Components, Inc., 155 Rt. 46 W, Wayne, NJ. 07470 TEL: (973)785-1333 FAX: (973)785-0053
<http://www.cardinalxtal.com> E-Mail: cardinal@cardinalxtal.com

Specifications subject to change without notice. Check website for latest updates



Electrical Characteristics

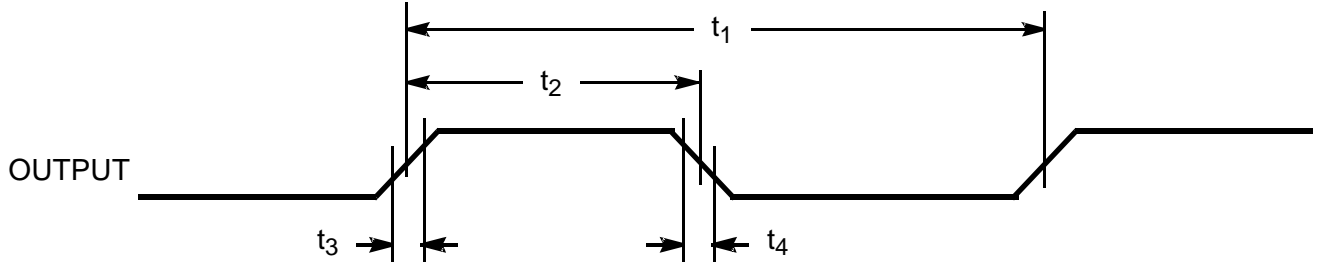
| DESCRIPTION | | CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------|----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|--------------|-----|--------------|
| Ioh | Output High Current | Voh = (L)Vdd - 0.5, (L)Vdd = 3.3 V | 12 | 24 | | mA |
| Iol | Output Low Current | Vol = .5, (L)Vdd = 3.3 V | 12 | 24 | | mA |
| Vih | High Level Input Voltage | CMOS levels, % of Vdd | 0.7 | | | V |
| Vil | Low-Level Input Voltage | CMOS levels, % of Vdd | | | 0.3 | V |
| Iih | Input High Current | Vin = AVdd - 0.3 V | | <1 | 10 | μA |
| Iil | Input Low Current | Vin = + 0.3 V | | <1 | 10 | μA |
| Ioz | Output Leakage Current | tri-state outputs | | | 10 | μA |
| Idd | Total Power Supply Current | Example 1: 1 output@200 MHz; 1 output@66.666 MHz 1 output@100 MHz; 1 output@50 MHz 1 output@25 MHz; 1 output@12 MHz; Example 2: 1 output@200 Mhz; 1 output@155.52 MHz 1 output@100 Mhz; 1 output@77.76 MHz 1 output@50 Mhz; 1 output@12 MHz; | | 35 39 | | mA mA |
| Idds | Shutdown Power Supply Curr | Shutdown active | | 5 | 20 | μA |

Output Clock Switching Characteristics

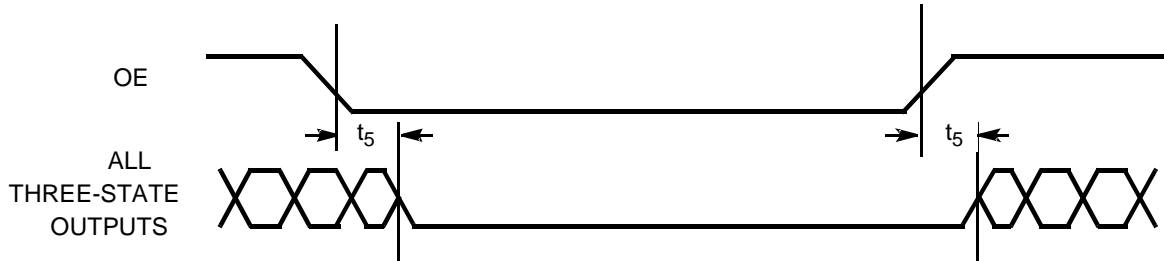
| DESCRIPTION | | CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------|----------------------------------------------|-----------------------------------------------|------|-----|-----|------|
| 1/t1 | Output Frequency | Clock output limit, CMOS, Commercial | | | 200 | MHz |
| t3 | Rising Edge Slew Rate | Output clock rise time, 20% – 80% Vdd | 0.75 | 1.4 | | nS |
| t4 | Falling Edge Slew Rate | Output clock fall time, 20% – 80% Vdd | 0.75 | 1.4 | | nS |
| t5 | Output tri-state timing after SD/OE switches | Time for output to enter/leave tri-state mode | | 150 | 300 | nS |
| t6 | Clock Jitter measured at Vdd/2 | Peak-to-Peak period jitter, CLK outputs | | 200 | | pS |
| | Frequency Switch Time | Change time | | 2 | 4 | ms |



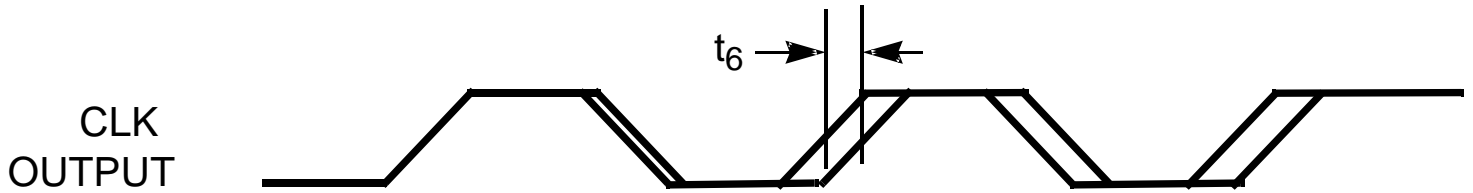
ALL OUTPUTS, DUTY CYCLE, RISE/FALL TIME



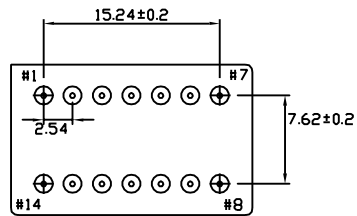
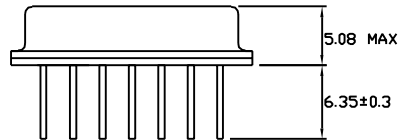
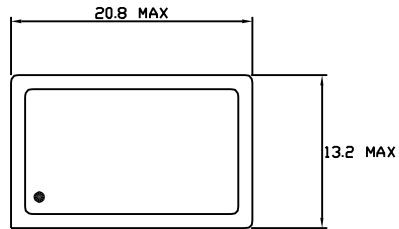
OUTPUT TRI-STATE TIMING



CLK OUTPUT JITTER



DIP

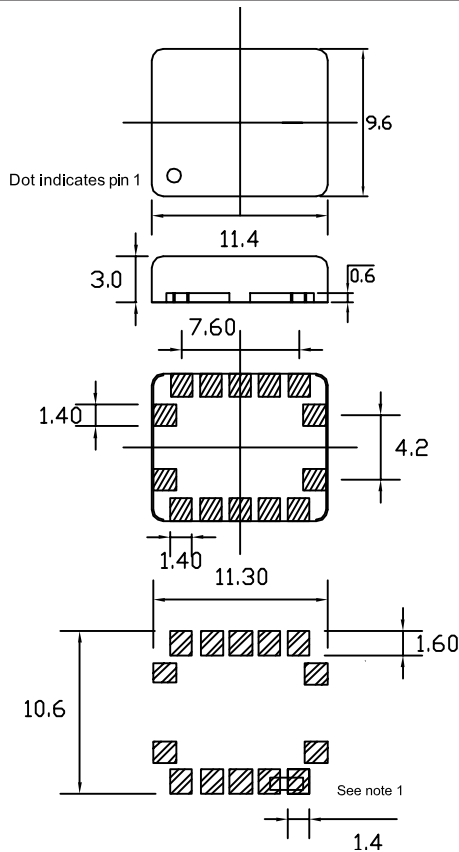


Dimensions are in mm

PIN FUNCTION

- PIN 1 OE (CONNECT TO VDD)
- PIN 2 SUSPEND (CONNECT TO GND)
- PIN 3 VDD
- PIN 4 CLK C OUTPUT
- PIN 5 CONNECT TO PIN 6
- PIN 6 CONNECT TO PIN 5
- PIN 7 GND
- PIN 8 12 MHz REF CLOCK OUTPUT
- PIN 9 CLK D OUTPUT
- PIN 10 CLK E OUTPUT
- PIN 11 SDAT
- PIN 12 SCLK
- PIN 13 CLK A OUTPUT
- PIN 14 CLK B OUTPUT

SMD



PIN FUNCTION

- PIN 1 FACTORY USE (MAKE NO CONNECTION)
- PIN 2 OE
- PIN 3 VDD
- PIN 4 CLK C OUTPUT
- PIN 5 CONNECT TO PIN 6
- PIN 6 CONNECT TO PIN 5
- PIN 7 GND
- PIN 8 12 MHz REF CLOCK OUTPUT
- PIN 9 CLK D OUTPUT
- PIN 10 CLK E OUTPUT
- PIN 11 SCLK
- PIN 12 SDAT
- PIN 13 CLK A OUTPUT
- PIN 14 CLK B OUTPUT

Dimensions in mm
Recommended solder pad layout

Note1:
For proper operation pin 5 must be connected to pin 6



Flash Programmability:

Non-Volatile programming enables easy customization, ultrafast turnaround, performance tweaking, design timing margin testing, inventory control, lower part count, and more secure product supply. In addition, any part in the family can also be programmed multiple times, which reduces programming errors and provides an easy upgrade path for existing designs.

Feature of the I²C-bus:

- Only two bus lines are required; a serial data line (SDA) and a serial clock line (SCL)
- Each device connected to the bus is software addressable by a unique address and simple master/slave relationship exist at all times; master can operate as a master-transmitter or as master-receivers
- It's a true multi-master bus including collision detection and arbitration to prevent data corruption if two or more master simultaneously initiate data transfer
- Serial 8-bit oriented, bidirectional data transfers can be made at up to 100 Kbit/s in the standard mode, up to 400 kbit/s in the fast-mode, or up to 3.4 Mbit/s in the High-speed mode

Designer Benefits:

I²C bus compatible In Circuit Reconfigurable Oscillator "ICRO" allow a system design to rapidly progress directly from a functional block diagram to a prototype. Moreover, since they 'clip' directly onto the I²C bus without any additional external interfacing, they allow a prototype system to be modified or upgraded simply by 'clipping' or 'unclipping' ICRO to or from the bus.

Here are some of the feature of I²C- bus compatible ICRO which are particularly attractive to designer

- Functional blocks on the block diagram correspond with the actual ICRO designs proceed rapidly from block diagram to final schematic
- No need to design bus interfaces because the I²C-bus interface is already integrated on the ICRO
- Integrated addressing and data-transfer protocol allow systems to be completely software-defined
- The same ICRO types can often be used in many different applications
- Design-time reduces as designers quickly become familiar with the frequently used functional book represented by I²C-bus compatible and ICRO
- ICRO can be added to or remove from system without affecting any other circuits on the bus

In addition to these advantages, the CMOS ICRO in the I²C-bus compatible range offer designers special feature which are particularly attractive for portable equipment and battery-backed systems.

They All Have:

- Extremely low current consumption
- High Noise immunity
- Wide operating temperature range

Manufacturer Benefits

I²C-bus compatible ICRO don't only assist designer, they also give a wider range of benefits to the equipment manufacturer because:

- The simple 2-wire serial I²C bus minimizes interconnections so ICRO have fewer pins and there are not so many PCB tracks; result- smaller and less expensive PCBs
- The completely integrated I²C-bus protocol eliminates the need for address decoders and other 'glue logic'
- The multi-master capability of the I²C-bus allows rapid testing and alignment of end-user equipment via external connections to an assembly line
- I²C-bus handbook, I²C Website: www.semiconductors.philips.com/I2C

